

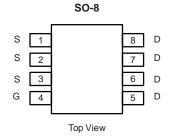
AFP9566WS8RG-VB Datasheet P-Channel 30-V (D-S) MOSFET

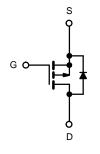
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)				
	0.033 at V _{GS} = - 10 V	- 5.8				
- 30	0.043 at V _{GS} = - 6 V	- 5.0				
	0.056 at V _{GS} = - 4.5 V	- 4.4				

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 30		V
Gate-Source Voltage		V _{GS}	± 20		
	T _A = 25 °C	– I _D	- 5.8	- 4.1	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 4.6	- 3.2	
Pulsed Drain Current		I _{DM}	- 30		A
Continuous Source Current (Diode Conduction) ^a		۱ _S	- 2.3	- 1.1	
	T _A = 25 °C	Р	2.5	1.3	W
Maximum Power Dissipation ^a	T _A = 70 °C	P _D	1.6	0.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55	to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 s	R _{thJA}	40	50		
Maximum Junction-to-Ambient ^a	Steady State		70	95	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	24	30		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.7		- 2.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			- 5	μA	
h		$V_{DS} \leq$ - 10 V, V_{GS} = - 10 V $$ -				•	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	- 5			A	
Drain-Source On-State Resistance ^b		V _{GS} = - 10 V, I _D = - 5.8 A		0.033			
	R _{DS(on)}	$V_{GS} = -6 V, I_D = -5 A$ 0.043		0.043		Ω	
		V _{GS} = - 4.5 V, I _D = - 4.4 A		0.056).056		
Forward Transconductance ^b	g _{fs}	V _{DS} = - 15 V, I _D = - 5.8 A		13		S	
Diode Forward Voltage ^b	V _{SD}	I _S = - 2.3 A, V _{GS} = 0 V		- 0.8	- 1.1	V	
Dynamic ^a							
Total Gate Charge	Qg			16	24		
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 3.5 A		2.3		nC	
Gate-Drain Charge	Q _{gd}			4.5			
Gate Resistance	R _g			8.8		Ω	
Turn-On Delay Time	t _{d(on)}			14	25		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 15 Ω		14	25		
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ I _D \cong - 1 A, V _{GEN} = - 10 V, R _g = 6 Ω		42	70	ns	
Fall Time	t _f			30	50		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.2 A, dl/dt = 100 A/μs		30	60		

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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T_C = 125 °C

 V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics

C_{iss}

Coss

15

V_{DS} - Drain-to-Source Voltage (V)

Capacitance

20

25

30

3

- 55 °C

4

5

25 °C

2

1

Crss

5

0

25

50

T_J - Junction Temperature (°C)

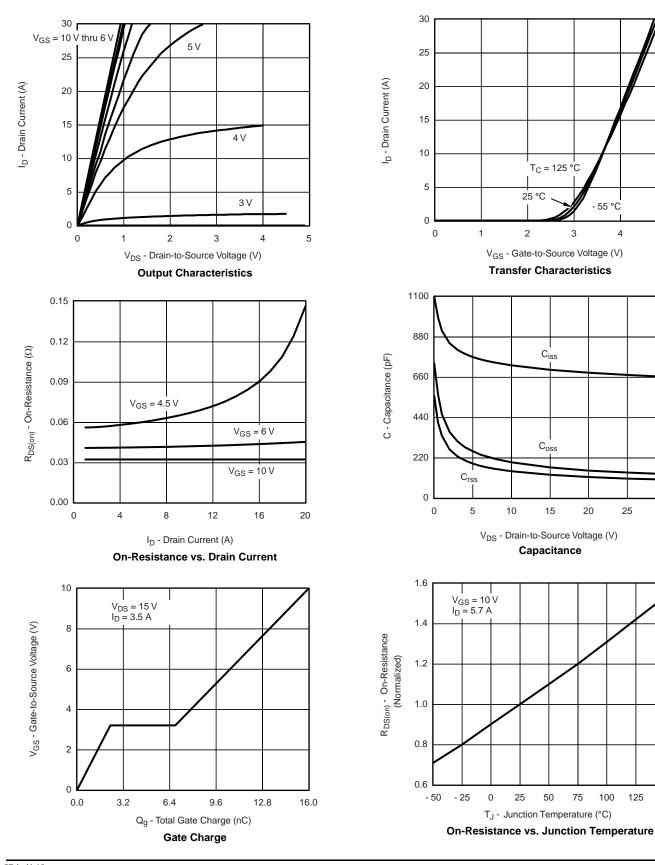
75

100

125 150

10

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

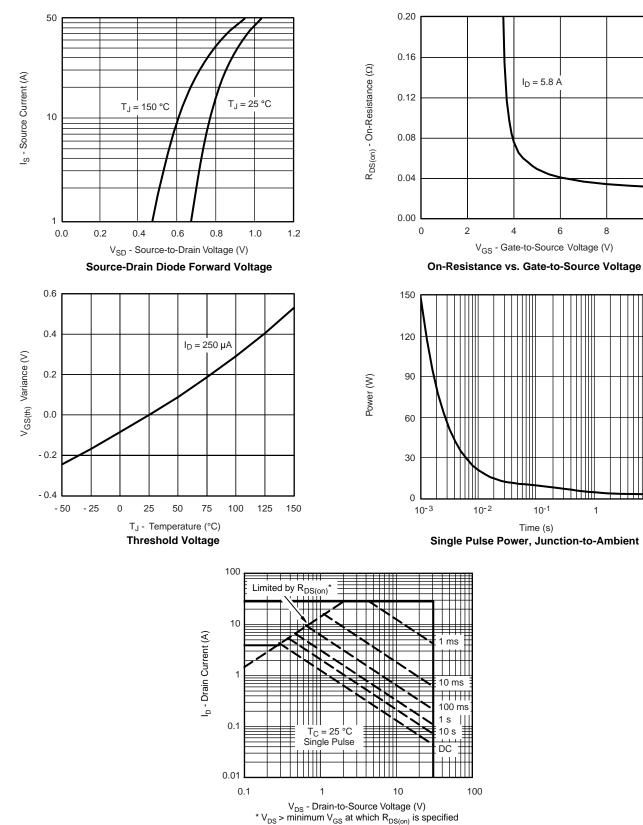




8

10

10

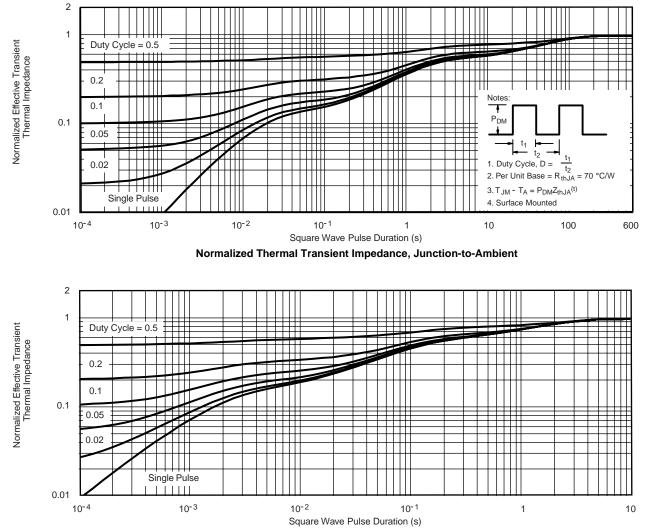


Safe Operating Area, Junction-to-Foot

TYPICAL CHARACTERISTICS 25 C, unless otherwise noted



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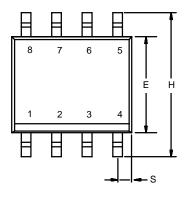


Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

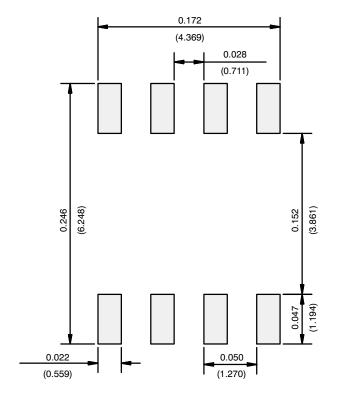




	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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